

100V N-Channel SGT Enhancement Mode MOSFET

Description

The PECN1045G uses Shield Gate Trench technology that is uniquely optimized to provide the most efficient high frequency switching performance. Both conduction and switching power losses are minimized due to an extremely low combination of $R_{DS(ON)}$ and Q_g . This device is ideal for high-frequency switching and synchronous rectification.

General Features

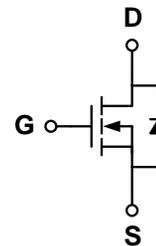
- ◆ $V_{DS} = 100V$ $I_D = 45A$
 $R_{DS(ON)}(Typ.) = 14.0m\Omega$ @ $V_{GS} = 10V$
 $R_{DS(ON)}(Typ.) = 18.5m\Omega$ @ $V_{GS} = 4.5V$
- ◆ Excellent gate charge x $R_{DS(on)}$ product(FOM)
- ◆ Very low on-resistance $R_{DS(on)}$
- ◆ 150 °C operating temperature
- ◆ 100% UIS tested

100% UIS TESTED!
100% ΔVds TESTED!

Application

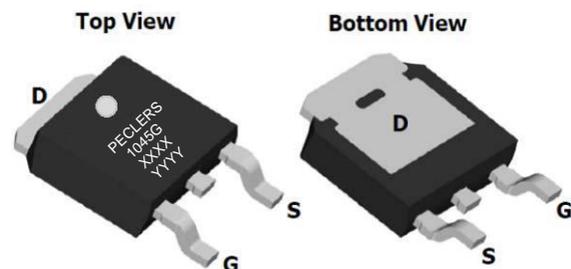
- ◆ Synchronous Rectification in DC/DC and AC/DC Converters
- ◆ Industrial and Motor Drive applications

Schematic diagram



Marking and pin assignment

TO-252-2L



Note:

XXXX—Wafer Information

YYYY—Quality Code



Ordering Information

| Part Number | Storage Temperature | Package | Devices Per Reel |
|-------------|---------------------|-----------|------------------|
| PECN1045G | -55°C to +150°C | TO-252-2L | 2500 |

Absolute Maximum Ratings (TA=25°C unless otherwise noted)

| parameter | symbol | limit | unit |
|--|----------|---------|------|
| Drain-source voltage | V_{DS} | 100 | V |
| Gate-source voltage | V_{GS} | ±20 | V |
| Continuous Drain Current | I_D | TC=25°C | 45 |
| | | TC=70°C | 36 |
| Pulsed Drain Current | I_{DP} | 180 | A |
| Avalanche energy(L=0.5mH) ^(note1) | E_{AS} | 200 | mJ |
| Power Dissipation | P_D | TC=25°C | 85 |
| | | TC=70°C | 45 |
| Operating junction Temperature range | T_j | -55—150 | °C |

Electrical Characteristics (TA=25°C unless otherwise noted)

| Parameter | Symbol | Condition | Min | Typ | Max | Unit |
|---|--------------|--|-----|------|-----------|------------|
| Static Characteristics | | | | | | |
| Drain-source breakdown voltage | BV_{DSS} | $V_{GS}=0V, I_D=250\mu A$ | 100 | - | - | V |
| Zero gate voltage drain current | I_{DSS} | $V_{DS}=100V, V_{GS}=0V$ | - | - | 1 | μA |
| | | $T_J=55^\circ C$ | - | - | 5 | |
| Gate Leakage Current | I_{GSS} | $V_{DS}=0V, V_{GS}=\pm 20V$ | - | - | ± 100 | nA |
| Gate threshold voltage | $V_{GS(th)}$ | $V_{DS}=V_{GS}, I_D=250\mu A$ | 1.0 | 1.75 | 2.5 | V |
| Drain-source on-state resistance ¹ | $R_{DS(ON)}$ | $V_{GS}=10V, I_D=45A$ | - | 14.0 | 18 | m Ω |
| | | $V_{GS}=4.5V, I_D=30A$ | - | 18.5 | 24 | |
| Forward Transconductance | g_{FS} | $V_{DS}=5V, I_D=20A$ | - | 35 | - | S |
| Diode Characteristics | | | | | | |
| Diode Forward Voltage | V_{SD} | $I_{SD}=1A, V_{GS}=0V$ | - | 0.7 | 1.2 | V |
| Diode Continuous Forward Current | I_S | | - | - | 60 | A |
| Reverse Recovery Time | t_{rr} | $T_J = 25^\circ C, I_F = 45A, di/dt = 100A/\mu s$ | - | 25 | - | ns |
| Reverse Recovery Charge | Q_{rr} | | - | 80 | - | nC |
| Dynamic Characteristics² | | | | | | |
| Gate Resistance | R_G | $V_{GS}=0V, V_{DS}=0V, f=1MHz$ | - | 1.2 | 1.8 | Ω |
| Input capacitance | C_{ISS} | $V_{GS}=0V, V_{DS}=50V, f=1.0MHz$ | - | 1600 | - | pF |
| Output capacitance | C_{OSS} | | - | 140 | - | |
| Reverse transfer capacitance | C_{RSS} | | - | 11 | - | |
| Turn-on delay time | $t_{D(ON)}$ | $V_{GS}=10V, V_{DS}=50V, R_L=2.5\Omega, R_G=3\Omega$ | - | 6 | - | ns |
| Turn-on Rise time | t_r | | - | 2 | - | |
| Turn-off delay time | $t_{D(OFF)}$ | | - | 18 | - | |
| Turn-off Fall time | t_f | | - | 2 | - | |
| Total gate charge | Q_g | $V_{GS}=10V, V_{DS}=50V, I_D=20A$ | - | 26 | - | nC |
| Gate-source charge | Q_{gs} | | - | 7.4 | - | |
| Gate-drain charge | Q_{gd} | | - | 3.8 | - | |

Note: 1: Pulse test; pulse width $\leq 300ns$, duty cycle $\leq 2\%$.

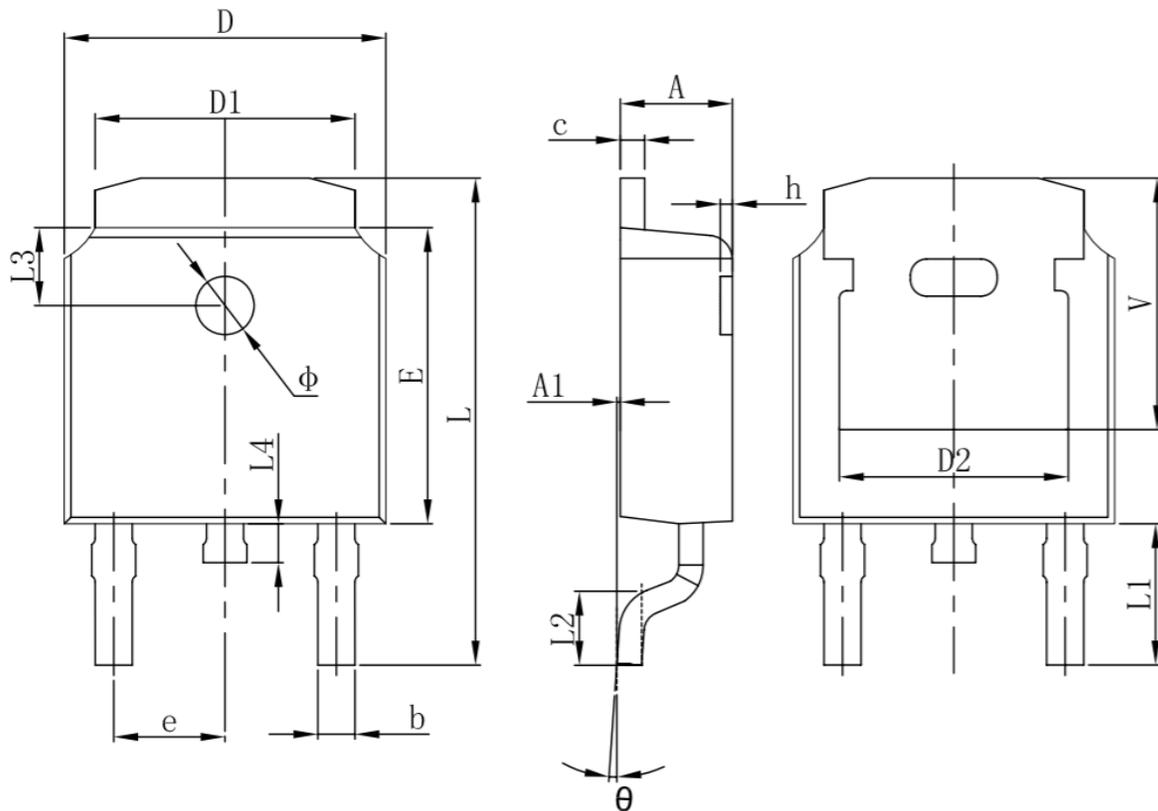
2: Guaranteed by design, not subject to production testing.

Thermal Characteristics

| Parameter | Symbol | Typical | Unit |
|--|-----------------|---------|--------------|
| Thermal Resistance-Junction to Case | $R_{\theta JC}$ | 1.7 | $^\circ C/W$ |
| Thermal Resistance junction-to ambient | $R_{\theta JA}$ | 62.5 | |

Package Information

- TO-252-2L



| Symbol | Dimensions In Millimeters | | Dimensions In Inches | |
|--------|---------------------------|--------|----------------------|-------|
| | Min. | Max. | Min. | Max. |
| A | 2.200 | 2.400 | 0.087 | 0.094 |
| A1 | 0.000 | 0.127 | 0.000 | 0.005 |
| b | 0.635 | 0.770 | 0.025 | 0.030 |
| c | 0.460 | 0.580 | 0.018 | 0.023 |
| D | 6.500 | 6.700 | 0.256 | 0.264 |
| D1 | 5.100 | 5.460 | 0.201 | 0.215 |
| D2 | 4.830 REF. | | 0.190 REF. | |
| E | 6.000 | 6.200 | 0.236 | 0.244 |
| e | 2.186 | 2.386 | 0.086 | 0.094 |
| L | 9.712 | 10.312 | 0.382 | 0.406 |
| L1 | 2.900 REF. | | 0.114 REF. | |
| L2 | 1.400 | 1.700 | 0.055 | 0.067 |
| L3 | 1.600 REF. | | 0.063 REF. | |
| L4 | 0.600 | 1.000 | 0.024 | 0.039 |
| Φ | 1.100 | 1.300 | 0.043 | 0.051 |
| θ | 0° | 8° | 0° | 8° |
| h | 0.000 | 0.300 | 0.000 | 0.012 |
| V | 5.250 REF. | | 0.207 REF. | |